

HD74ALVC1G06

Single Inverter Buffer / Driver with Open Drain

REJ03D0108-0500 Rev.5.00 Sep 08, 2006

Description

The HD74ALVC1G06 has an inverter in a 5 pin package. Low voltage and high-speed operation is suitable for the battery powered products (e.g., notebook computers), and the low power consumption extends the battery life.

Features

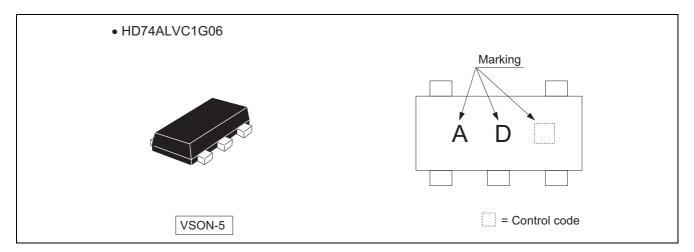
- The basic gate function is lined up as Renesas uni logic series.
- Supplied on emboss taping for high-speed automatic mounting.
- Supply voltage range: 1.2 to 3.6 V
- Operating temperature range : -40 to +85°C
- All inputs V_{IH} (Max.) = 3.6 V (@ V_{CC} = 0 V to 3.6 V)
- All outputs V_0 (Max.) = 3.6 V (@ V_{CC} = 0 V, Output : Z)
- Output current $2 \text{ mA} (@V_{CC} = 1.2 \text{ V})$

4 mA (@ V_{CC} = 1.4 V to 1.6 V) 6 mA (@ V_{CC} = 1.65 V to 1.95 V) 18 mA (@ V_{CC} = 2.3 V to 2.7 V) 24 mA (@ V_{CC} = 3.0 V to 3.6 V)

• Ordering Information

Part Name	Package Type	Package Code (Previous Code)	Package Abbreviation	Taping Abbreviation (Quantity)
HD74ALVC1G06VSE	VSON-5 pin	PUSN0005KA-A (TNP-5DV)	VS	E (3,000 pcs/reel)

Outline and Article Indication

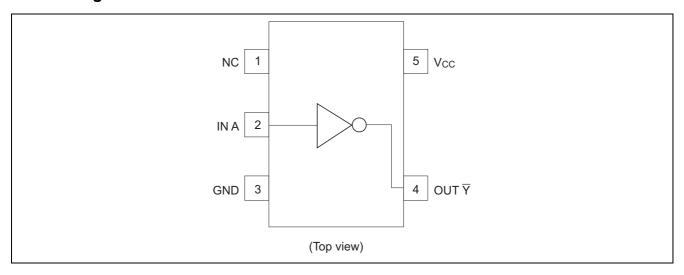


Function Table

Input A	Output ₹
Н	L
L	Z

H: High levelL: Low levelZ: High impedance

Pin Arrangement



Absolute Maximum Ratings

Item	Symbol	Ratings	Unit	Conditions
Supply voltage range	V _{CC}	-0.5 to 4.6	V	
Input voltage range *1	VI	-0.5 to 4.6	V	
Output voltage range *1, 2	Vo	-0.5 to V _{CC} +0.5	V	Output : L
Output voltage range	Vo.	-0.5 to 4.6	V	V _{CC} : OFF or Output : Z
Input clamp current	I _{IK}	-50	mA	V ₁ < 0
Output clamp current	I _{OK}	-50	mA	V _O < 0
Continuous output current	lo	±50	mA	$V_O = 0$ to V_{CC}
Continuous current through V _{CC} or GND	I _{CC} or I _{GND}	±100	mA	
Maximum power dissipation at Ta = 25°C (in still air) *3	P _T	200	mW	
Storage temperature	Tstg	-65 to 150	°C	

Notes: The absolute maximum ratings are values, which must not individually be exceeded, and furthermore, no two of which may be realized at the same time.

- 1. The input and output voltage ratings may be exceeded if the input and output clamp-current ratings are observed.
- 2. This value is limited to 4.6 V maximum.
- 3. The maximum package power dissipation was calculated using a junction temperature of 150°C.

Recommended Operating Conditions

Item	Symbol	Min	Max	Unit	Conditions
Supply voltage range	V _{CC}	1.2	3.6	V	
Input voltage range	VI	0	3.6	V	
Output voltage range	Vo	0	3.6	V	
		_	2		V _{CC} = 1.2 V
	I _{OL}	_	4	mA	V _{CC} = 1.4 V
Output current		_	6		V _{CC} = 1.65 V
		_	18		V _{CC} = 2.3 V
		_	24		V _{CC} = 3.0 V
Input transition rise or fall rate	Δt / Δν	0	20	ns / V	V _{CC} = 1.2 to 2.7 V
input transition rise of fall fate	Δι / Δν	0	10	115 / V	$V_{CC} = 3.3\pm0.3 \text{ V}$
Operating free-air temperature	Та	-40	85	°C	

Note: Unused or floating inputs must be held high or low.

Electrical Characteristics

 $(Ta = -40 \text{ to } 85^{\circ}C)$

Item	Symbol	V _{CC} (V) *1	Min	Тур	Max	Unit	Test Conditions
		1.2	V _{CC} ×0.75	_			
		1.4 to 1.6	V _{CC} ×0.7	_	_		
	V_{IH}	1.65 to 1.95	V _{CC} ×0.7	_	_		
		2.3 to 2.7	1.7	_	_		
Input voltage		3.0 to 3.6	2.0	_	_	V	
Input voltage		1.2	_	_	V _{CC} ×0.25	V	
		1.4 to 1.6	_	_	V _{CC} ×0.3		
	V_{IL}	1.65 to 1.95	_	_	V _{CC} ×0.3		
		2.3 to 2.7	_	_	0.7		
		3.0 to 3.6	_	_	0.8		
		Min to Max	_	_	0.2		$I_{OL} = 100 \mu A$
		1.2	_	_	0.3		$I_{OL} = 2 \text{ mA}$
Output voltage	V _{OL}	1.4	_	_	0.3	V	I _{OL} = 4 mA
Output voltage	VOL	1.65	_	_	0.3	V	I _{OL} = 6 mA
		2.3	_	_	0.55		I _{OL} = 18 mA
		3.0	_	_	0.55		I _{OL} = 24 mA
Input current	I _{IN}	3.6	_	_	±5	μΑ	$V_{IN} = 3.6 \text{ V or GND}$
Off state output current	l _{oz}	3.6	_	_	±5	μΑ	$V_{OUT} = V_{CC}$ or GND
Quiescent supply current	I _{CC}	3.6	_	_	10	μΑ	$V_{IN} = V_{CC}$ or GND, $I_O = 0$
Output leakage current	I _{OFF}	0	_	_	5	μΑ	V_{IN} or $V_{OUT} = 0$ to 3.6 V
Input capacitance	C _{IN}	3.3	_	4.5	_	pF	$V_{IN} = V_{CC}$ or GND

Note: For conditions shown as Min or Max, use the appropriate values under recommended operating conditions.

Switching Characteristics

 $V_{CC} = 1.2 \text{ V}$

Item	tem Symbol		= -40 to 8	5°C	Unit	Test Conditions	FROM	ТО
item	Syllibol	Min	Тур	Max	Unit	rest Conditions	(Input)	(Output)
Propagation delay time	t _{ZL}	_	5.0	_	ns	C _L = 15 pF	Α	Ÿ

 $V_{CC} = 1.5 \pm 0.1 \text{ V}$

Item	Symbol	Та	= -40 to 85	5°C	Unit	Unit Test Conditions		то
item	Symbol	Min	Тур	Max	Ollic	rest conditions	(Input)	(Output)
Propagation delay time	t _{ZL} t _{LZ}	1.0	_	7.0	ns	C _L = 15 pF	А	Y

 $V_{CC} = 1.8 \pm 0.15 \text{ V}$

Symbol Ta = -40 to 85°C Unit Tost		Tost Conditions	FROM	то			
Syllibol	Min	Тур	Max	Ollit	rest conditions	(Input)	(Output)
t _{ZL}	1.0	_	5.0	ns	C _L = 30 pF	А	Y
		Symbol Min	Min Typ tzl. 1.0 —	Min Typ Max tzL 1.0 — 5.0	Symbol Min Typ Max Unit	Min Typ Max Unit Test Conditions tz_L 1.0 — 5.0 ns C _L = 30 pF	SymbolMinTypMaxUnitTest Conditions t_{ZL} 1.0—5.0ns $C_L = 30 \text{ pF}$ A

 $V_{CC} = 2.5 \pm 0.2 \text{ V}$

Item	Symbol	Та	= -40 to 8	5°C	Unit	Test Conditions	FROM	ТО
item	Syllibol	Min	Тур	Max	Unit	rest Conditions	(Input)	(Output)
Propagation	t _{ZL}	0.5	_	3.5	ns	$C_L = 30 pF$	А	Ÿ
delay time	t_LZ							

 $V_{CC} = 3.3 \pm 0.3 \text{ V}$

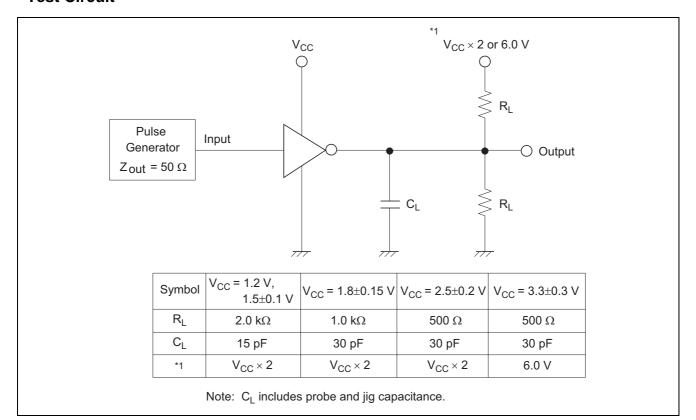
Item	Symbol Ta = -40 to 85°C Unit Test		Test Conditions	FROM	ТО			
item	Syllibol	Min	Тур	Max	Ollit	rest Conditions	(Input)	(Output)
Propagation delay time	t _{ZL}	0.5	_	2.5	ns	C _L = 30 pF	А	Y

Operating Characteristics

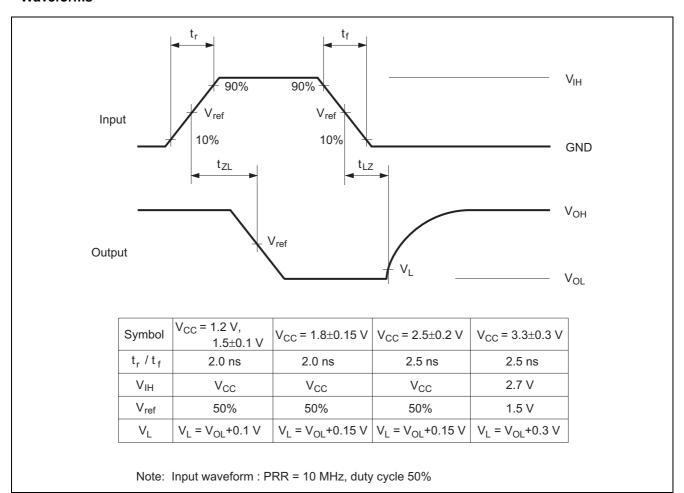
 $(Ta = 25^{\circ}C)$

Item	Symbol	V _{CC} (V)	Min	Тур	Max	Unit	Test Conditions
Power dissipation capacitance		1.5		1.5	_		
	C _{PD}	1.8	_	1.5	_	pF	f = 10 MHz
		2.5	_	2.0	_		
		3.3		3.0	_		

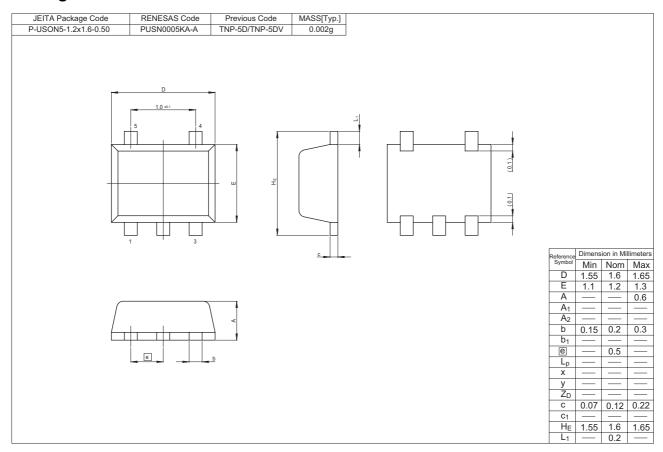
Test Circuit



Waveforms



Package Dimensions



Renesas Technology Corp. Sales Strategic Planning Div. Nippon Bldg., 2-6-2, Ohte-machi, Chiyoda-ku, Tokyo 100-0004, Japan

Keep safety first in your circuit designs!

1. Renesas Technology Corp. puts the maximum effort into making semiconductor products better and more reliable, but there is always the possibility that trouble may occur with them. Trouble with semiconductors may lead to personal injury, fire or property damage.

Remember to give due consideration to safety when making your circuit designs, with appropriate measures such as (i) placement of substitutive, auxiliary circuits, (ii) use of nonflammable material or (iii) prevention against any malfunction or mishap.

- Notes regarding these materials

 1. These materials are intended as a reference to assist our customers in the selection of the Renesas Technology Corp. product best suited to the customer's application; they do not convey any license under any intellectual property rights, or any other rights, belonging to Renesas Technology Corp. or a third party.

 2. Renesas Technology Corp. assumes no responsibility for any damage, or infringement of any third-party's rights, originating in the use of any product data, diagrams, charts, programs, algorithms, or circuit application examples contained in these materials.

 3. All information contained in these materials, including product data, diagrams, charts, programs and algorithms represents information on products at the time of publication of these materials, and are subject to change by Renesas Technology Corp. without notice due to product improvements or other reasons. It is therefore recommended that customers contact Renesas Technology Corp. or an authorized Renesas Technology Corp. product distributor for the latest product information before purchasing a product listed herein.

 The information described here may contain technical inaccuracies or typographical errors.

 Renesas Technology Corp. assumes no responsibility for any damage, liability, or other loss rising from these inaccuracies or errors.

 Please also pay attention to information published by Renesas Technology Corp. by various means, including the Renesas Technology Corp. Semiconductor home page (http://www.renesas.com).

- home page (http://www.renesas.com).

 4. When using any or all of the information contained in these materials, including product data, diagrams, charts, programs, and algorithms, please be sure to evaluate all information as a total system before making a final decision on the applicability of the information and products. Renesas Technology Corp. assumes no responsibility for any damage, liability or other loss resulting from the information contained herein.

 5. Renesas Technology Corp. semiconductors are not designed or manufactured for use in a device or system that is used under circumstances in which human life is potentially at stake. Please contact Renesas Technology Corp. or an authorized Renesas Technology Corp. product distributor when considering the use of a product contained herein for any specific purposes, such as apparatus or systems for transportation, vehicular, medical, aerospace, nuclear, or undersea repeater use.
- use.

 6. The prior written approval of Renesas Technology Corp. is necessary to reprint or reproduce in whole or in part these materials.

 7. If these products or technologies are subject to the Japanese export control restrictions, they must be exported under a license from the Japanese government and cannot be imported into a country other than the approved destination.

 Any diversion or reexport contrary to the export control laws and regulations of Japan and/or the country of destination is prohibited.

 8. Please contact Renesas Technology Corp. for further details on these materials or the products contained therein.



RENESAS SALES OFFICES

http://www.renesas.com

Refer to "http://www.renesas.com/en/network" for the latest and detailed information.

Renesas Technology America, Inc. 450 Holger Way, San Jose, CA 95134-1368, U.S.A Tel: <1> (408) 382-7500, Fax: <1> (408) 382-7501

Renesas Technology Europe Limited
Dukes Meadow, Millboard Road, Bourne End, Buckinghamshire, SL8 5FH, U.K.
Tel: <44> (1628) 585-100, Fax: <44> (1628) 585-900

Renesas Technology (Shanghai) Co., Ltd.

Neitesas Technology (offangriar) 63., Ed. Unit 204, 205, AZIACenter, No. 1233 Lujiazui Ring Rd, Pudong District, Shanghai, China 200120 Tel: <86> (21) 5877-1818, Fax: <86> (21) 6887-7898

Renesas Technology Hong Kong Ltd.
7th Floor, North Tower, World Finance Centre, Harbour City, 1 Canton Road, Tsimshatsui, Kowloon, Hong Kong Tel: <852> 2265-6688, Fax: <852> 2730-6071

Renesas Technology Taiwan Co., Ltd.10th Floor, No.99, Fushing North Road, Taipei, Taiwan Tel: <886> (2) 2715-2888, Fax: <886> (2) 2713-2999

Renesas Technology Singapore Pte. Ltd.
1 Harbour Front Avenue, #06-10, Keppel Bay Tower, Singapore 098632 Tel: <65> 6213-0200, Fax: <65> 6278-8001

Renesas Technology Korea Co., Ltd. Kukje Center Bldg. 18th Fl., 191, 2-ka, Hangang-ro, Yongsan-ku, Seoul 140-702, Korea Tel: <82> (2) 796-3115, Fax: <82> (2) 796-2145

Renesas Technology Malaysia Sdn. Bhd
Unit 906, Block B, Menara Amcorp, Amcorp Trade Centre, No.18, Jalan Persiaran Barat, 46050 Petaling Jaya, Selangor Darul Ehsan, Malaysia Tel: <603> 7955-9390, Fax: <603> 7955-9510

© 2006 Renesas Technology Corn. All rights reserved. Printed in Japan